



1F6W



UNITED STATES PATENT AND TRADEMARK OFFICE

UNITED STATES DEPARTMENT OF COMMERCE
United States Patent and Trademark Office
Address: COMMISSIONER FOR PATENTS
P.O. Box 1450
Alexandria, Virginia 22313-1450
www.uspto.gov

APPL NO.	FILING OR 371 (c) DATE	ART UNIT	FIL FEE REC'D	ATTY. DOCKET NO	DRAWINGS	TOT CLMS	IND CLMS
10/661,616	09/15/2003	2811	822	EI-2-03-001-CIP-3	12	24	3

CONFIRMATION NO. 8507

Lawrence R. Fraley
IP Law Counsel
Endicott Interconnect Technologies, Inc.
1701 North Street, FBU/257-2 AA12
Endicott, NY 13760

FILING RECEIPT



OC000000011452873

Date Mailed: 12/10/2003

Receipt is acknowledged of this regular Patent Application. It will be considered in its order and you will be notified as to the results of the examination. Be sure to provide the U.S. APPLICATION NUMBER, FILING DATE, NAME OF APPLICANT, and TITLE OF INVENTION when inquiring about this application. Fees transmitted by check or draft are subject to collection. Please verify the accuracy of the data presented on this receipt. If an error is noted on this Filing Receipt, please write to the Office of Initial Patent Examination's Filing Receipt Corrections, facsimile number 703-746-9195. Please provide a copy of this Filing Receipt with the changes noted thereon. If you received a "Notice to File Missing Parts" for this application, please submit any corrections to this Filing Receipt with your reply to the Notice. When the USPTO processes the reply to the Notice, the USPTO will generate another Filing Receipt incorporating the requested corrections (if appropriate).

Applicant(s)

Lawrence R. Fraley, Jupiter, FL;
Voya Markovich, Endwell, NY;

Assignment For Published Patent Application

Endicott Interconnect Technologies, Inc., Endicott, NY;

Domestic Priority data as claimed by applicant

This application is a CIP of 10/394,107 03/24/2003
which is a CIP of 10/354,000 01/30/2003

Foreign Applications

If Required, Foreign Filing License Granted: 12/05/2003

Projected Publication Date: 08/05/2004

Non-Publication Request: No

Early Publication Request: No

Title



BEST AVAILABLE COPY

BEST AVAILABLE COPY

Date: 9/12/03

~~Express Mail No.~~ Airborne Express #5994945762

Please Acknowledge and Return

☒ Application ☐ Issue Fee
☒ Declaration 2 pgs. ☐ Draftsman w/Dwgs.
x signed unsigned ☒ Cert. Of Mailing
☒ Assignment w/Cover Pg. ☐
☒ IDS/PTO-1449/Refs.
☐ Amendment
Title Stacked Chip Electronic Package Having Laminate
Carrier And Method Of Making Same
31 Pgs. Spec. 24 Claims 12 Shts. Of Drawing
\$822.00 Filing Fee Attorney Lawrence R. Fraley
Docket RI-2-03-001-CIP-3
In Appln. Of V. Markovich et al
Serial/Inter. Number
Filed Herewith

03945 U.S. PTO

10/661616



09/15/03

Received by U.S.
Patent Office